

Engineering Change Notice

設變通知書

Issue Date 發行日	18 May, 2018
Object 主旨	Engineering Change Notice (ECN)
Category 產品類別	115A and 115Q SIM card series socket
Product No. 產品料號	115A-BDA0-R01 115A-ADA0-R02 115Q-BCA0
Purpose 設變目的	Mechanical design update to solve socket and card contact issue for nano SIM to Micro SIM/Mini SIM card adaptor
Suggested Equivalent Parts 建議替代料	N/A
Difference 差異說明	Mechanical enhancement as attachment Drawing Edition: 1. 115A-ADA0-R02 REV.4 2. 115A-BDA0-R01 REV.5 3. 115Q-BCA0 REV.4
Technical Effect 技術變異	N/A
Remark 備註	This is running changed, may delivery both typs during this time without special note.

To each of ATTEND customers & partners,
 致 立威科技股份有限公司的客戶及合作夥伴：

The above is our Engineering Change Notification(ECN), in order to achieve excellent product management, we will from time to time through the ECN process, and then optimize the product design to ensure that our good customers can gain high-performance product quality.

以上是我們的產品設計變更通知信函，為了達到更精良的產品管理，我們將會不定期的透過設計變更流程，進而優化產品的設計，以確保客戶能獲得高效能的產品品質。

Thanks for your cooperation in advance.
 感謝您的配合。

ATTEND Technology Inc.
 立威科技股份有限公司

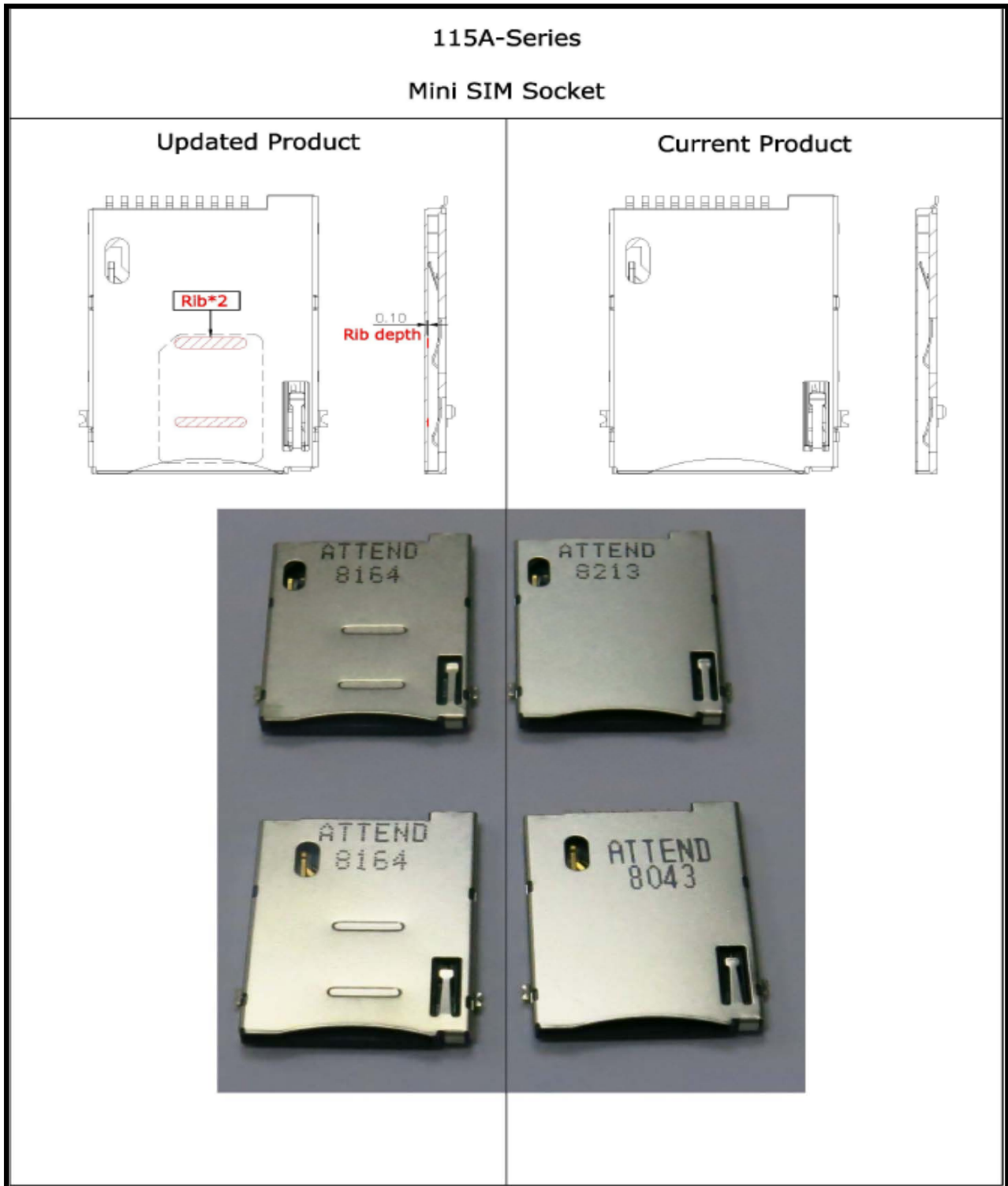
Steven Chang

Steven Chang / Products Marketing
 張耀文 / 產品行銷

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Comparison



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